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1.5A, 200V - 600V Surface Mount Super Fast Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

MECHANICAL DATA

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 16mg (approximately)

KEY PARAMETERS					
PARAMETER VALUE UNIT					
I _{F(AV)}	1.5	Α			
V_{RRM}	200 - 600	V			
I _{FSM}	40 A				
$T_{J MAX}$	150	°C			
Package	SOD-123W				
Configuration	Single die				









SOD-123W

PARAMETER	SYMBOL	ES15DLW	ES15GLW	ES15JLW	UNIT
Marking code on the device		ES15D	ES15G	ES15J	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	V
Forward current	I _{F(AV)}		1.5		Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	40		А	
Junction temperature	T_J		-55 to +150		°C
Storage temperature	T _{STG}		-55 to +150		°C

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	26	°C/W		
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	76	°C/W		
Junction-to-case thermal resistance per diode	R _{eJC}	27	°C/W		

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

PARAMETER		CONDITIONS SYMBOL		TYP	MAX	UNIT
	ES15DLW	$I_F = 0.75A, T_J = 25^{\circ}C$		0.80	-	٧
		I _F = 1.50A, T _J = 25°C		0.85	0.95	V
		I _F = 0.75A, T _J = 125°C		0.66	-	V
		I _F = 1.50A, T _J = 125°C		0.73	0.8	V
	ES15GLW	$I_F = 0.75A, T_J = 25^{\circ}C$		0.87	-	V
Forward voltage per diode		I _F = 1.50A, T _J = 25°C	V _F	0.95	1.3	V
(1)		I _F = 0.75A, T _J = 125°C		0.72	-	V
		I _F = 1.50A, T _J = 125°C		0.80	1.05	V
	ES15JLW	I _F = 0.75A, T _J = 25°C		1.06	-	V
		I _F = 1.50A, T _J = 25°C		1.18	1.7	V
		I _F = 0.75A, T _J = 125°C		0.84	-	٧
		I _F = 1.50A, T _J = 125°C		0.97	1.3	V
Reverse current @ rated V _R per diode ⁽²⁾		T _J = 25°C	,	-	1	μΑ
		T _J = 125°C	l _R	-	150	μΑ
	ES15DLW		CJ	24	-	pF
Junction capacitance	ES15GLW	1 MHz, V _R =4.0V		21	-	pF
	ES15JLW			20	-	pF
Reverse recovery time		I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	35	ns

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms



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ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX(*)	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
ES15xLW		RV	6	SOD-123W	3,000 / 7" Reel
(Note 1,2)	H	RQ	G	SOD-123W	10,000 / 13" Reel

Notes:

- 1. "x" defines voltage from 200V (ES15DLW) to 600V (ES15JLW)
- 2. Whole series with green compound (halogen-free)
- *: Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ES15DLWHRVG	ES15DLW	Н	RV	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

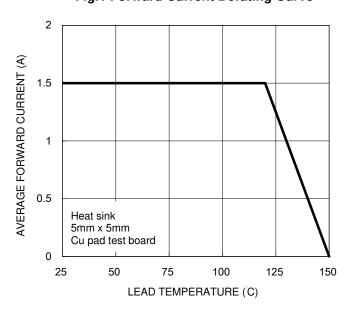


Fig.2 Typical Junction Capacitance

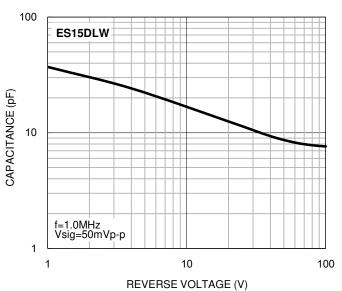


Fig.3 Typical Reverse Characteristics

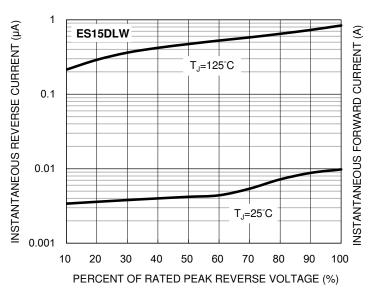
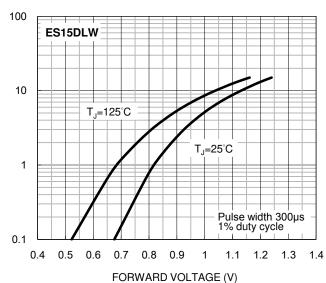


Fig.4 Typical Forward Characteristics



4

Fig.6 Typical Reverse Characteristics



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Typical Junction Capacitance

100 10 INSTANTANEOUS REVERSE CURRENT (µA) ES15GLW ES15GLW T_J=125°C 1 CAPACITANCE (pF) 0.1 10 0.01 $T_J=25^{\circ}C$ f=1.0MHz Vsig=50mVp-p 0.001 1 20 30 40 50 60 70 80 100 10 100 PERCENT OF RATED PEAK REVERSE VOLTAGE (%) REVERSE VOLTAGE (V)

Fig.7 Typical Forward Characteristics

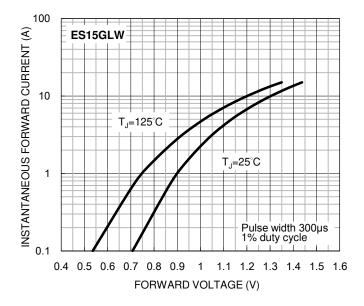


Fig.9 Typical Reverse Characteristics

80

90

100

70



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.8 Typical Junction Capacitance

100

20

30

40

50

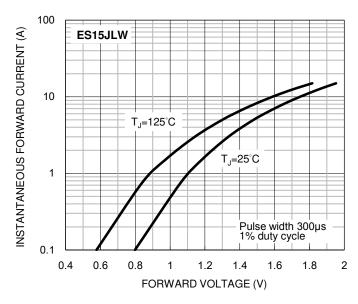
60

PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

Fig.10 Typical Forward Characteristics

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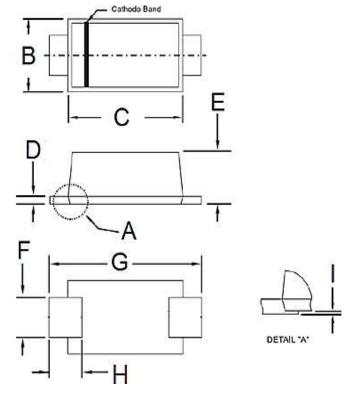
REVERSE VOLTAGE (V)





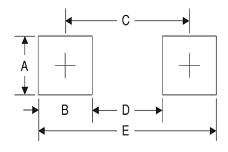
PACKAGE OUTLINE DIMENSIONS

SOD-123W



DIM.	Unit	(mm)	Unit (inch)		
DIW.	Min	Max	Min	Max	
В	1.70	1.90	0.067	0.075	
С	2.60	2.90	0.102	0.114	
D	0.10	0.22	0.004	0.009	
E	0.90	1.02	0.035	0.040	
F	0.90	1.05	0.035	0.041	
G	3.60	3.80	0.142	0.150	
Н	0.50	0.85	0.020	0.033	
Ī	0.00	0.10	0.000	0.004	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
Е	4.3	0.169

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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